Messrs. Digi-Key

 Issue No.
 : PC-02-051

 Date of issue : November 15, 2002

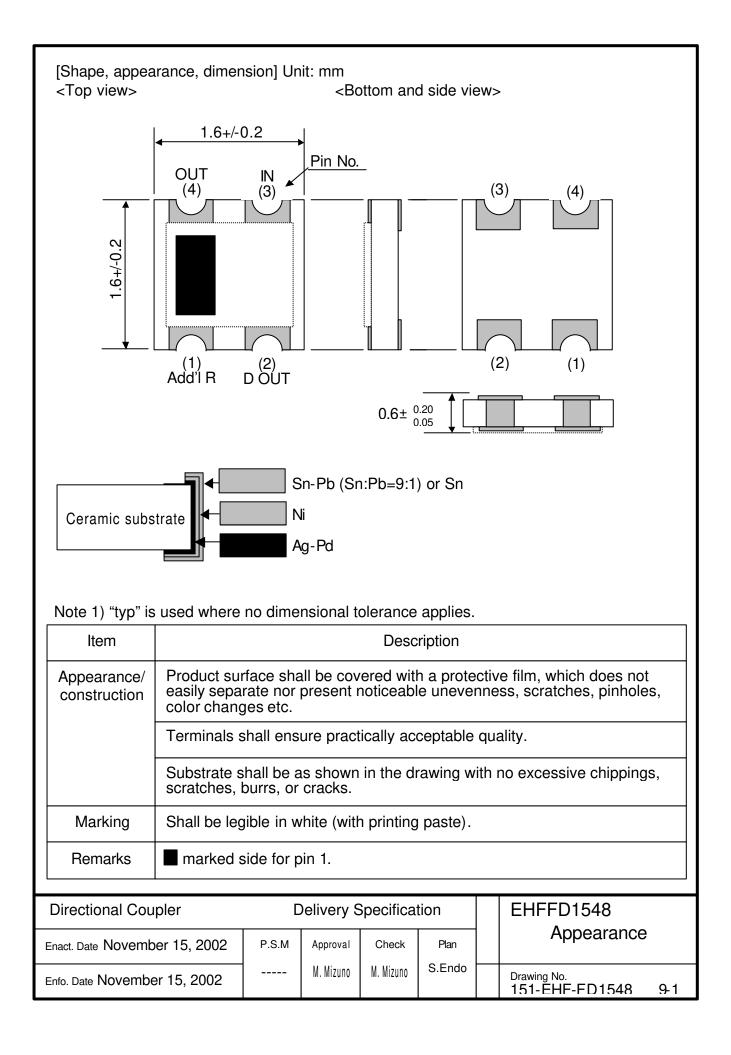
 Classification : ■ New □ Change □ Renewal

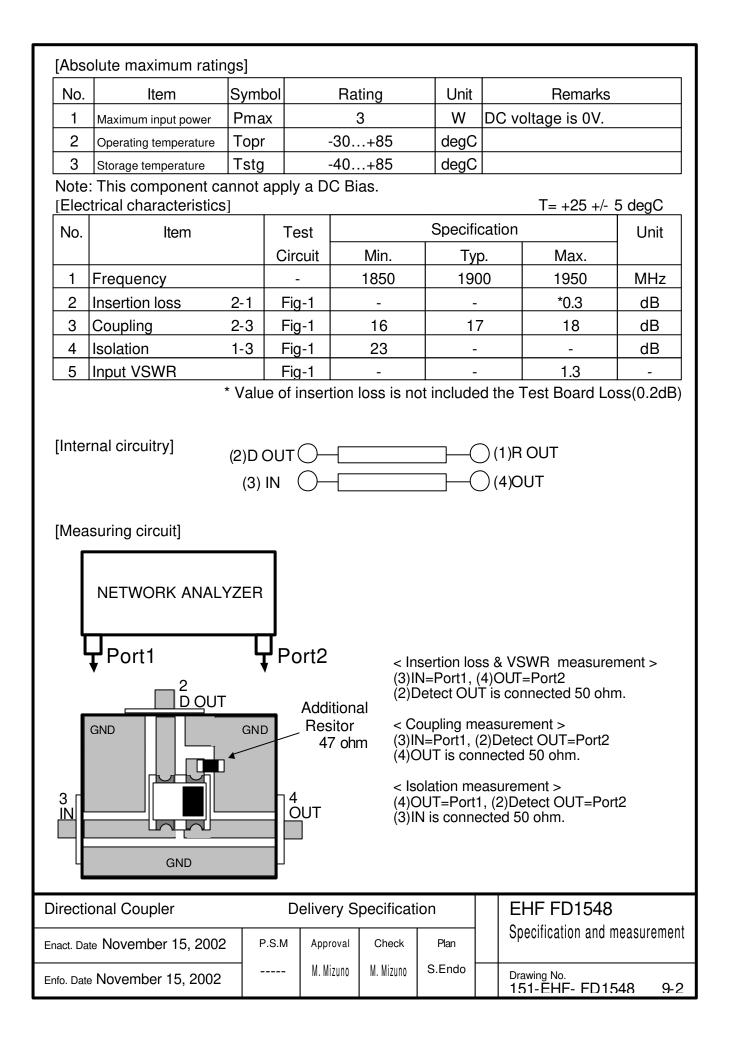
Delivery Specification

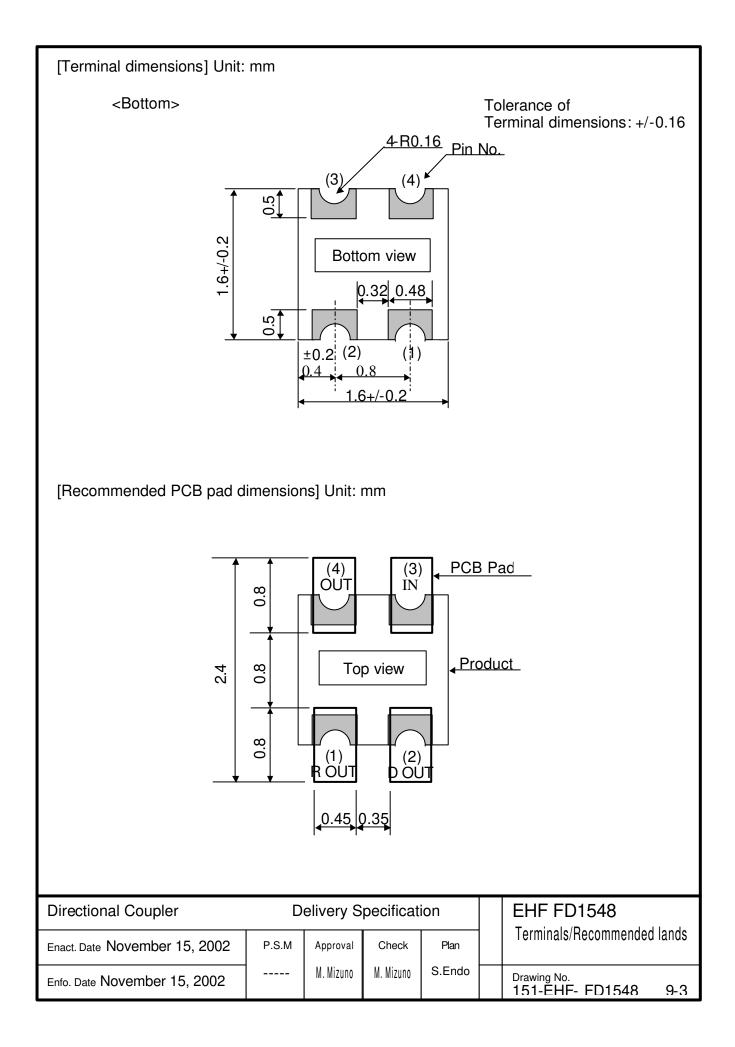
Product Description	: Directional Coupler
Product Part Number	: EHFFD1548
Classification of Spec	: Individual Product Specification
Applications	: Cellular phone
	For other applications, contact the undersigned in advance.
Term of Validity	: November 14, 2007 from the date of issue.

CUSTOMER USE ONLY	Receipt Record#:	
This was certainly received by us. 1(one) copy is being returned to you.	Date of receipt:	
	Received by:	
	Title: Dept.:	

Matsushita Electronic Components Co., Ltd.			
Network Device Company	Prepared by	: S.Endo	
Module Strategic Business Unit	Checked by	: M. Mizuno	
Engineering Group HFD Team			
992-1 Aiba Ohno-cho Ibi-gun Gifu 501-0598 JAPAN	Authorized by	: M. Mizuno	
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[Quality characteristic	s]						
Test item	Test condition	Judgment criteria					
High temperature	+85degC, 1000h	No abnormality shall be observed in					
Low temperature	-40degC, 1000h	appearance or					
High-temperature high-humidity storage	+60degC, 90%RH, 1000h	electrical characteristics.					
Pressure Pot	+121degC, 99%RH, 2.026x10 ⁵ Pa, 100h	characteristics.					
Temperature cycling	-40+85degC, Each 30 min., 200cy						
Vibration	10500Hz, 10G, in each direction of XYZ, 2h30min.						
Impact	100G, 6mS, Half sinusoidal wave, in each direction of XYZ, 3 times						
Shock (Drop)	1.8m, 6 facesx6cy(36 times with 100g Dummy Load)						
Electro static discharge	200pF, 0 ohm, +/-200V, Each 5 times						
Soldering heat resistance	Manual hot gas: 260+/-10degC, 30 sec., 2 times	Over 90% of the terminal surface shall be covered					
	Soldering iron: 260+/-10degC, 3 sec., 2 times	with solder.					
	Reflow: 260degC peak, 2 times						
Solder ability	Solder bath: 235+/-5degC, 2 sec.	Over 95% of the terminal surface shall be covered					
	Reflow: 230degC	with solder.					
Board warping	There should not be any cracks in the component or solder joints, no abnormality in electrical characteristics.						
Terminal removal	Solder a component on a PC board using the recommended of then press the component sideways at 1mm/sec. Destruction lir						
Seating plane co-planarity	Within 0.1mm						
< Recommended soldering condition > Diagram1 Shown below is a recommended reflow soldering condition. degC 250 200 170 140 30~60 sec. 60~180 sec. Time							
Directional Coupler	FD1548 lity Characteristics						
Enact. Date November 15, 2 Enfo. Date November 15, 20	002 P.S.M Approval Check Plan M. Mizuno M. Mizuno S.Endo Drawin	g No.					
151-ĚHF- FD1548 9-4							

[Cautions for use]

(1) Operating a product over the	maximum rating for	even a moment	may result in a
product failure or breakage.	Never use a product	in such a condit	ion that it may
cause a safety problem.			

- (2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
- (3) Operations in a corrosive gas atmosphere or improper environments such as hightemperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
- (4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
- (5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
- (6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
- (7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
- (8) This product does not include a DC-cutting device. Application of a DC Current may cause product deterioration or breakage.
 - * If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.

[Remarks]

- *1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
- *2: The production process of this product does not use any ozone-depleting chemicals (OZC) regulated by the Montreal Protocol.
- *3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

Directional Coupler	Delivery Specification			EHF FD1548	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Cautions
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF- FD1548 9-5

[Packaging mat	erials]
1. Materials	1)

- 1) Embossed carrier tape (Refer to the attachment)
 2) Top tape: Anti-static
 3) Packaging box (Refer to the attachment)
 4) Packaging tape, carrier-securing adhesive tape

- 2. Specification

No.	Item	Condition						Remarks
1	Reel outer diameter	Refer t	the att					
2	Reel inner diameter	Refer t	the att	achment				
3	Reel inner width	Refer t	the att					
4	Quantity in a reel	4000 p	oieces/re	el				
5	Taping direction							
6	Top tape attachment position	Top tape	De attachm e edge mus Sprocket ho	Tape breaks force. Min. 10N Top cover tape strength. Min. 10N Tape peel force. 0.11.0N Tape peel angle. 165180degree Reel weight. Max 1500g				
7	Label attachment position			ing direction	Indicated Item Pat No., Lot No. Quantity, Maker Country			
8	Tape leader part and tape ending part	20	part Prod					
9 Missing products No missing products shall be allowed.								
10Packaged quantity in a box21reels/box (Max)84000 pieces/box(Max)								84000 pieces/box(Max)
					FD1548			
Enact. Date November 15, 2002 P.S.M Approval Check Plan					ging specification 1			
Enfo. Date November 15, 2002 M. Mizuno M. Mizuno S.Endo Drawing 151-E					^{№.} HF- FD1548 9-6			

